Power MOSFET 60 V, 1.2 mΩ, 287 A, Single N–Channel

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C604NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
60 V	1.2 mΩ @ 10 V	007 4	
00 V	1.7 mΩ @ 4.5 V	287 A	

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted) Parameter Symbol Value Unit Drain-to-Source Voltage VDSS 60 V Gate-to-Source Voltage V_{GS} ±20 V Continuous Drain $T_{\rm C} = 25^{\circ}{\rm C}$ 287 A I_D Current R_{0JC} $T_C = 100^{\circ}C$ 203 (Notes 1, 3) Steadv State Power Dissipation $T_C = 25^{\circ}C$ PD 200 W $R_{\theta JC}$ (Note 1) $T_{C} = 100^{\circ}C$ 100 $T_A = 25^{\circ}C$ Continuous Drain I_D 40 А Current R_{0JA} $T_A = 100^{\circ}\overline{C}$ 28 (Notes 1, 2, 3) Steady State Power Dissipation W $T_A = 25^{\circ}C$ P_D 3.9 $R_{\theta JA}$ (Notes 1 & 2) $T_A = 100^{\circ}\overline{C}$ 1.9 Pulsed Drain Current $T_A = 25^{\circ}C, t_p = 10 \ \mu s$ 900 А IDM **Operating Junction and Storage Temperature** T_J, T_{stg} -55 to °C +175Source Current (Body Diode) 203 А IS Single Pulse Drain-to-Source Avalanche 776 mJ E_{AS} Energy $(I_{L(pk)} = 22 \text{ A})$ Lead Temperature for Soldering Purposes T 260 °C (1/8" from case for 10 s)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

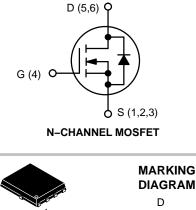
THERMAL RESISTANCE MAXIMUM RATINGS

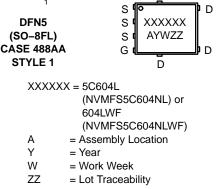
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.75	°C/W
Junction-to-Ambient - Steady State (Note 2)	R_{\thetaJA}	39	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.





ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

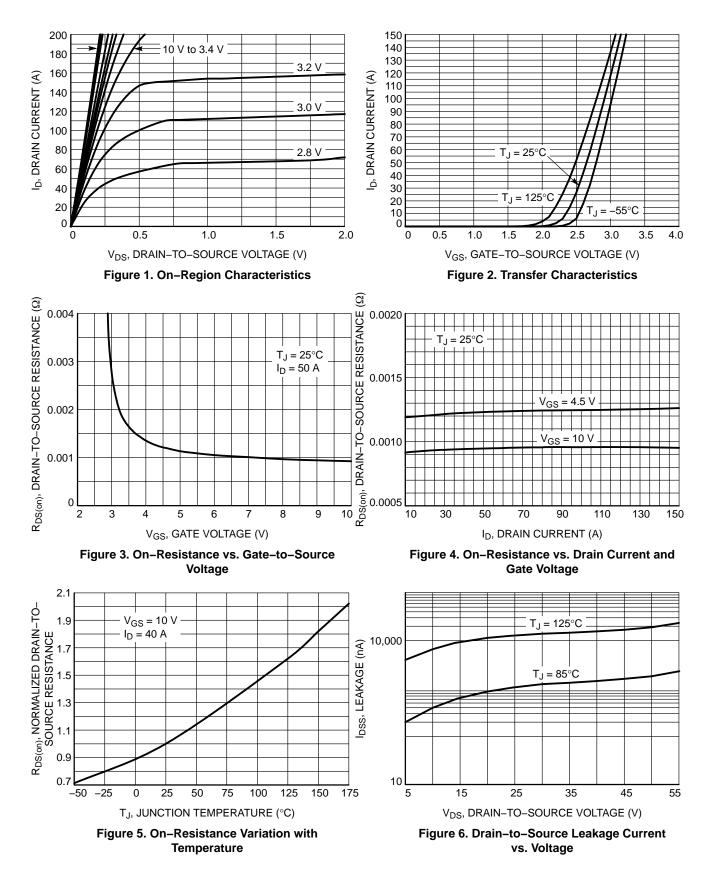
ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS		•					•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D$	= 250 μA	60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /				22.9		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			10	<u> </u>
		$V_{DS} = 60 \text{ V}$ $T_{J} = 125^{\circ}\text{C}$				250	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±16 V				±100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.9		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		0.93	1.2	
		V _{GS} = 4.5 V	I _D = 50 A		1.25	1.7	mΩ
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _D = 50 A			180		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						•
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			8900		pF
Output Capacitance	C _{OSS}				3750		
Reverse Transfer Capacitance	C _{RSS}				40		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 30 V; I _D = 50 A			52		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 30 V; I_{D} = 50 A			120		1
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 30 V; I _D = 50 A			6.4		nC V
Gate-to-Source Charge	Q _{GS}				21.4		
Gate-to-Drain Charge	Q _{GD}				12.7		
Plateau Voltage	V _{GP}				2.8		
SWITCHING CHARACTERISTICS (Note \$	5)						
Turn–On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 30 V, I _D = 50 A, R _G = 2.5 Ω			21.8		- ns
Rise Time	tr				79.1		
Turn–Off Delay Time	t _{d(OFF)}				57.8		
Fall Time	t _f				81.3		
DRAIN-SOURCE DIODE CHARACTERIS	STICS	4					
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V,$ $I_{S} = 50 A$	T _J = 25°C		0.78	1.2	
			T _J = 125°C		0.64		V
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/μs, I _S = 50 A			98		ns
Charge Time	ta				45		
Discharge Time	t _b				53		
Reverse Recovery Charge	Q _{RR}				190		nC

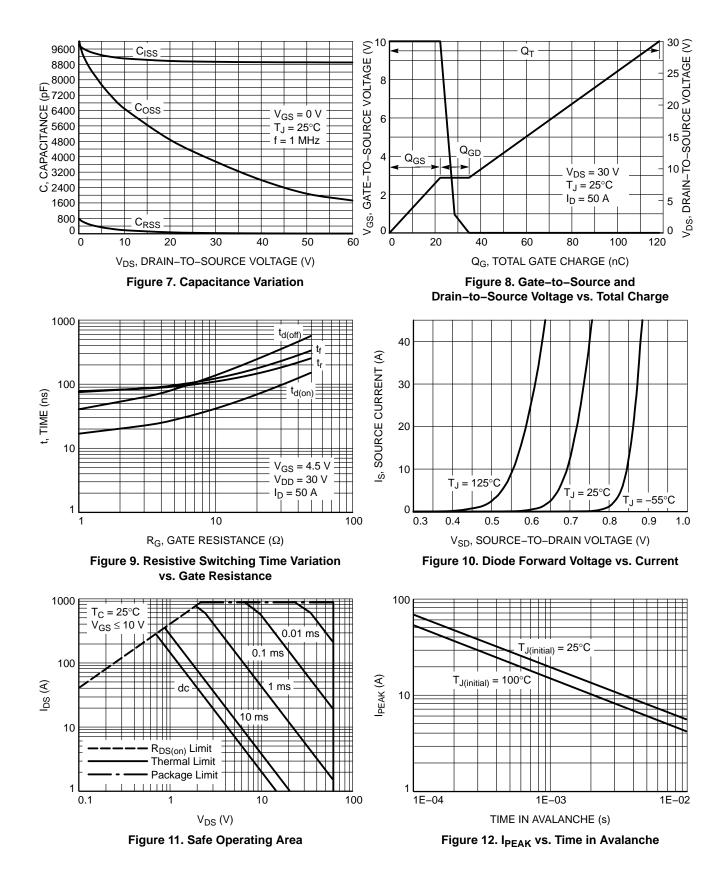
Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



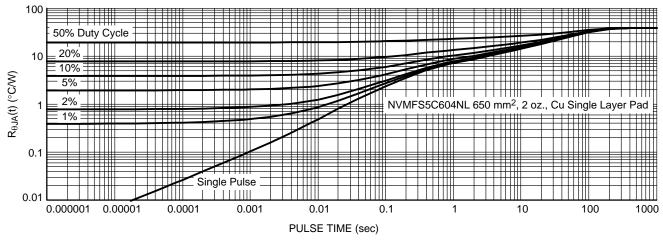


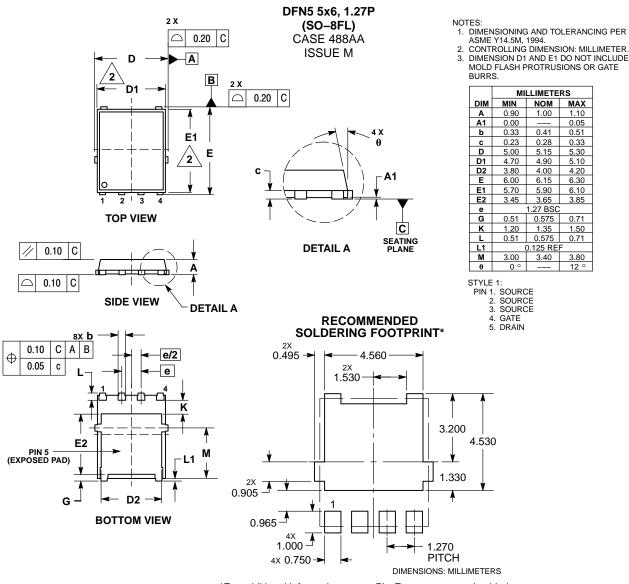
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFS5C604NLT1G	5C604L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C604NLWFT1G	604LWF	DFN5 (Pb–Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C604NLT3G	5C604L	DFN5 (Pb–Free)	5000 / Tape & Reel
NVMFS5C604NLWFT3G	604LWF	DFN5 (Pb–Free, Wettable Flanks)	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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